

## TO-220-3L Plastic-Encapsulate MOSFETS

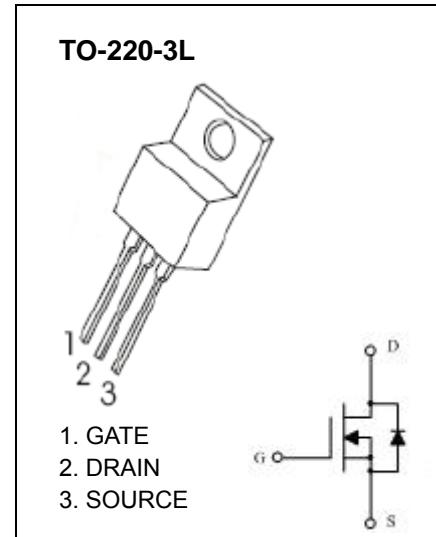
### CJP08N65 N-Channel Power MOSFET

#### GENERAL DESCRIPTION

This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.

#### FEATURE

- High Current Rating
- Lower  $R_{DS(on)}$
- Lower Capacitance
- Lower Total Gate Charge
- Tighter  $V_{SD}$  Specifications
- Avalanche Energy Specified



#### Maximum ratings ( $T_a=25^\circ\text{C}$ unless otherwise noted)

| Parameter  | Symbol          | Value      | Unit                      |
|--|-----------------|------------|---------------------------|
| Drain-Source Voltage   | $V_{DS}$        | 650        | V                         |
| Gate-Source Voltage  | $V_{GS}$        | $\pm 30$   |                           |
| Continuous Drain Current   | $I_D$           | 8          | A                         |
| Pulsed Drain Current   | $I_{DM}$        | 32         |                           |
| Single Pulsed Avalanche Energy (note1)                                   | $E_{AS}$        | 250        | mJ                        |
| Thermal Resistance from Junction to Ambient                              | $R_{\theta JA}$ | 62.5       | $^\circ\text{C}/\text{W}$ |
| Operating and Storage Temperature Range                                  | $T_J, T_{STG}$  | -55 ~ +150 | $^\circ\text{C}$          |
| Maximum Lead Temperature for Soldering Purposes , Duration for 5 Seconds | $T_L$           | 260        |                           |

**Electrical characteristics ( $T_a=25^\circ\text{C}$  unless otherwise noted)**

| Parameter                                 | Symbol                      | Test Condition   | Min | Typ | Max       | Unit          |
|---|-----------------------------|--|-----|-----|-----------|---------------|
| <b>Off characteristics</b>                |                             |  |     |     |           |               |
| Drain-source breakdown voltage            | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$                          | 650 |     |           | V             |
| Drain-source diode forward voltage        | $V_{\text{SD}}$             | $V_{\text{GS}} = 0\text{V}, I_S = 8\text{A}$                               |     |     | 1.4       |               |
| Zero gate voltage drain current           | $I_{\text{DSS}}$            | $V_{\text{DS}} = 650\text{V}, V_{\text{GS}} = 0\text{V}$                   |     |     | 10        | $\mu\text{A}$ |
| Gate-body leakage current                 | $I_{\text{GSS}}$            | $V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 30\text{V}$                |     |     | $\pm 100$ | nA            |
| <b>On characteristics (note2)</b>         |                             |  |     |     |           |               |
| Gate-threshold voltage                    | $V_{\text{GS}(\text{th})}$  | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$                      | 2.0 |     | 4.0       | V             |
| Static drain-source on-resistance         | $R_{\text{DS}(\text{on})}$  | $V_{\text{GS}} = 10\text{V}, I_D = 4\text{A}$                              |     | 1.0 | 1.4       | $\Omega$      |
| Forward transconductance                  | $g_{\text{fs}}$             | $V_{\text{DS}} = 50\text{V}, I_D = 3.9\text{A}$                            |     | 8.5 |           | S             |
| <b>Dynamic characteristics (note 3)</b>   |                             |  |     |     |           |               |
| Input capacitance                         | $C_{\text{iss}}$            | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$   |     |     | 1255      | pF            |
| Output capacitance                        | $C_{\text{oss}}$            |  |     |     | 135       |               |
| Reverse transfer capacitance              | $C_{\text{rss}}$            |  |     |     | 16        |               |
| <b>Switching characteristics (note 3)</b> |                             |  |     |     |           |               |
| Total gate charge                         | $Q_g$                       | $V_{\text{DS}} = 520\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 8\text{A}$ |     | 28  | 36        | nC            |
| Gate-source charge                        | $Q_{\text{gs}}$             |  |     | 4.5 |           |               |
| Gate-drain charge                         | $Q_{\text{gd}}$             |  |     | 12  |           |               |
| Turn-on delay time                        | $t_{\text{d}(\text{on})}$   | $V_{\text{DD}} = 325\text{V}, R_G = 25\Omega, I_D = 8\text{A}$             |     |     | 45        | ns            |
| Turn-on rise time                         | $t_r$                       |  |     |     | 130       |               |
| Turn-off delay time                       | $t_{\text{d}(\text{off})}$  |  |     |     | 170       |               |
| Turn-off fall time                        | $t_f$                       |  |     |     | 140       |               |

**Notes :**

1.  $L = 7\text{mH}, I_L = 8\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .
2. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
3. These parameters have no way to verify.